



ERNEST F. CHAPMAN
202-408-4096

December 3, 2001

ATTORNEY DOCKET NO. 08244.0032
CUSTOMER NO. 22,852



Box PATENT APPLICATION
Assistant Commissioner for Patents
Washington, DC 20231

New U.S. Patent Application

Title: METHOD FOR FORMING CONTACT HOLE AND SPACER OF
SEMICONDUCTOR DEVICE

Inventors Names and Residences:

1. Sung-Chan PARK, Kyongki-do, Korea;
2. Phil-Goo KONG, Kyongki-do, Korea; and
3. Kuk-Han YOON, Kyongki-do, Korea.

Sir:

We enclose the following papers for filing in the United States Patent and
Trademark Office in connection with the above patent application.

1. Application- 19 pages, including 2 independent claims and 20 claims total.
2. Drawings- 14 sheets of acceptable drawings containing 25 figures.
3. Certified copy of Korean Application No. 2000-75286, filed December 11, 2000.
4. The filing fee is calculated as follows:

Basic Application Filing Fee					\$740	\$ \$740.00
	Number of Claims		Basic	Extra Claims		
Total Claims	20	-	20	0	x \$18	
Independent Claims	2	-	3	0	x \$84	
<input type="checkbox"/> Presentation of Multiple Dep. Claim(s)					+\$280	
Subtotal						\$ 740.00
Reduction by 1/2 if small entity						-
TOTAL APPLICATION FILING FEE						\$ 740.00

A check for \$740.00 is enclosed for the filing fee.

This application is being filed under the provisions of 37 C.F.R. § 1.53(f). Applicants await notification from the Patent and Trademark Office of the time set for filing the Declaration.

Applicants claim the right to priority based on Korean Application No. 2000-75286, filed December 11, 2000.

Please address all correspondence with respect to this application to:

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Please accord this application an application number and filing date.

The Commissioner is hereby authorized to charge any additional filing fees due and any other fees due under 37 C.F.R. § 1.16 or §1.17 during the pendency of this application to our Deposit Account No. 06-0916.

Respectfully submitted,
FINNEGAN, HENDERSON, FARABOW,
GARRETT & DUNNER, L.L.P.

By:



Ernest F. Chapman
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EFC/FPD/peg
Enclosures